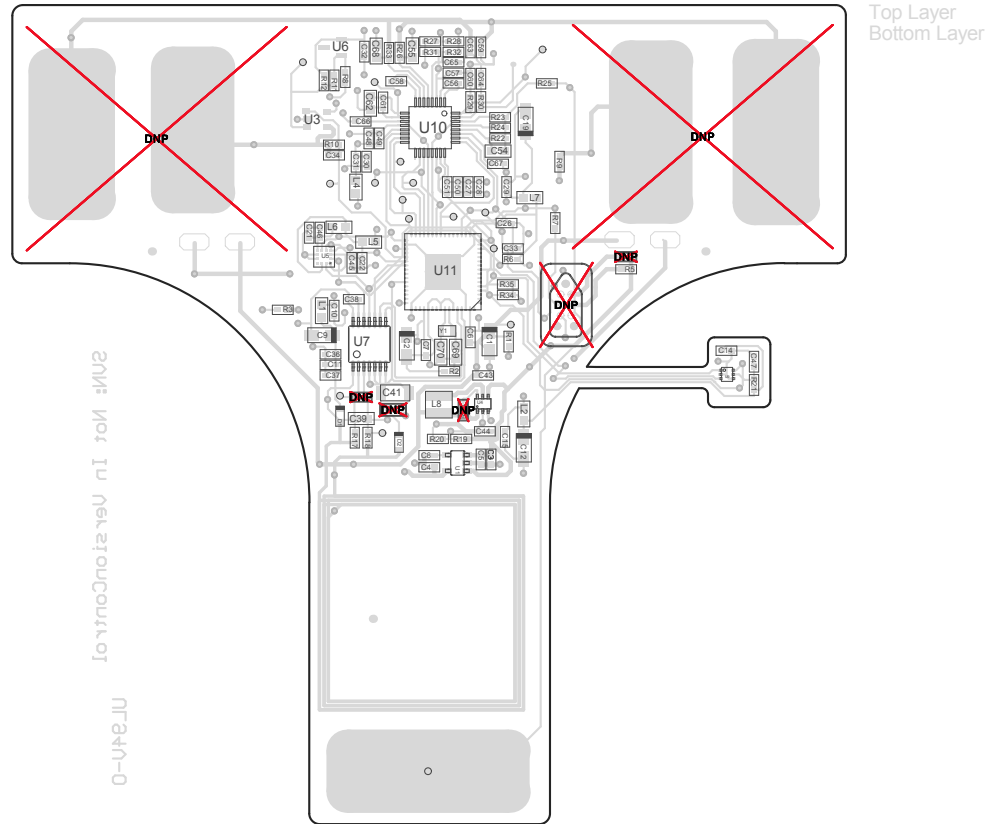


- ZZ1 ■ Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be in the Label Table in the PDF schematic.
- ZZ2 ■ These assemblies are ESD sensitive, ESD precautions shall be observed.
- ZZ3 ■ These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
- ZZ4 ■ These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

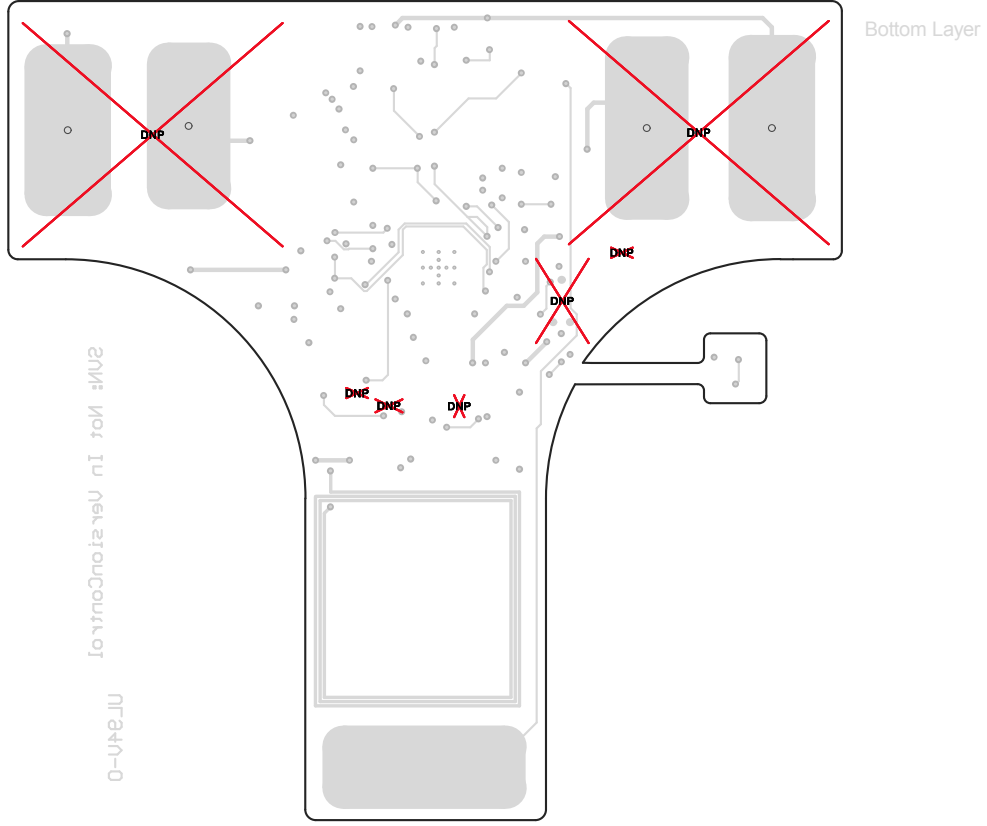


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
ASSEMBLY VARIANT: 001

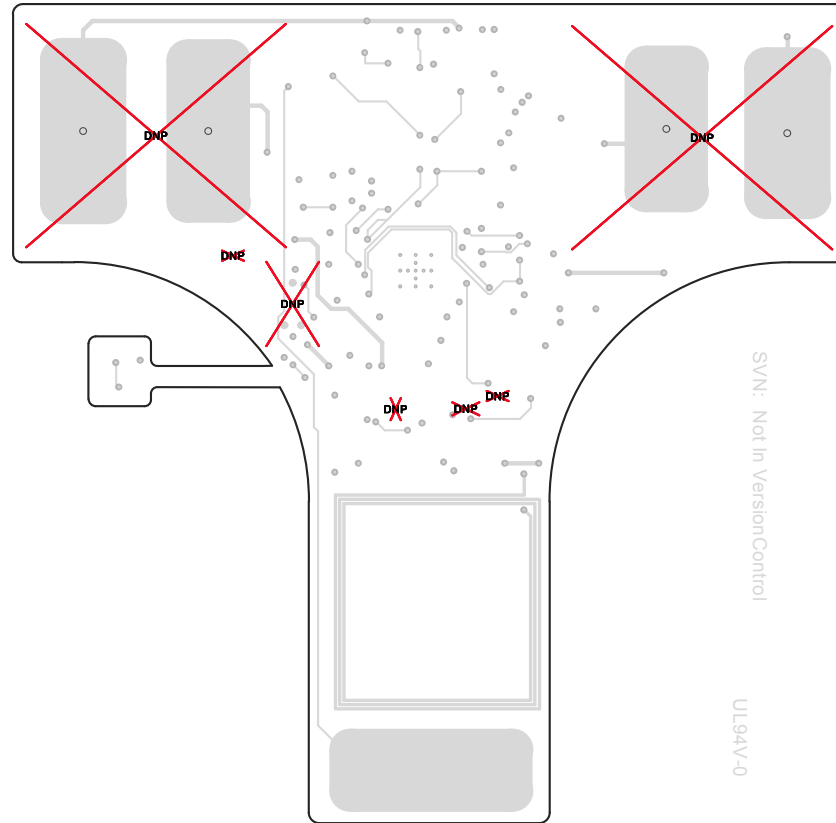
PCB VIEWED FROM TOP SIDE	BOARD #: XX####	REV: 002	SVN REV: Not In VersionControl
IGNORE ->			
PLOT NAME = Top Assembly Drawing	GENERATED : 3/26/2015	11:38:40 AM	TEXAS INSTRUMENTS

PLOT NAME = Bottom Assembly Drawing		GENERATED : 3/25/2015 11:38:41 AM		TEXAS INSTRUMENTS
IGNORE ->				
PCB VIEWED FROM BOTTOM SIDE		BOARD # : XXX###	REV: 002	SVN REV: Not In VersionControl

ASSEMBLY VARIANT: 001  
COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.



Bottom Layer  
MI Board Outline



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: XX####	REV: 002	SVN REV: Not In VersionControl
IGNORE ->			
PLOT NAME = Bottom Assembly Drawing Mirror	GENERATED : 3/26/2015	11:38:42 AM	TEXAS INSTRUMENTS

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